

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS III)

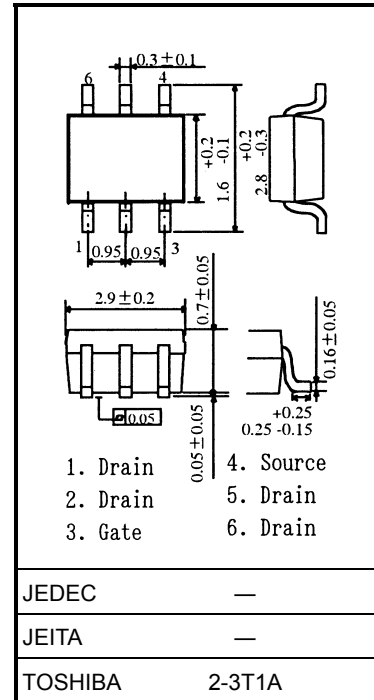
# TPC6103

## Notebook PC Applications

## Portable Equipment Applications

- Low drain-source ON resistance:  $R_{DS(ON)} = 29\text{ m}\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 13\text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = -10\text{ }\mu\text{A}$  (max) ( $V_{DS} = -12\text{ V}$ )
- Enhancement mode:  $V_{th} = -0.5\text{ to }-1.2\text{ V}$   
( $V_{DS} = -10\text{ V}, I_D = -200\text{ }\mu\text{A}$ )

Unit: mm



Weight: 0.011 g (typ.)

### Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	-12	V
Drain-gate voltage ( $R_{GS} = 20\text{ k}\Omega$ )		$V_{DGR}$	-12	V
Gate-source voltage		$V_{GSS}$	$\pm 8$	V
Drain current	DC (Note 1)	$I_D$	-5.5	A
	Pulse (Note 1)	$I_{DP}$	-22	
Drain power dissipation ( $t = 5\text{ s}$ ) (Note 2a)		$P_D$	2.2	W
Drain power dissipation ( $t = 5\text{ s}$ ) (Note 2b)		$P_D$	0.7	W
Single pulse avalanche energy (Note 3)		$E_{AS}$	5.3	mJ
Avalanche current		$I_{AR}$	-2.75	A
Repetitive avalanche energy (Note 4)		$E_{AR}$	0.22	mJ
Channel temperature		$T_{ch}$	150	$^{\circ}\text{C}$
Storage temperature range		$T_{stg}$	-55~150	$^{\circ}\text{C}$

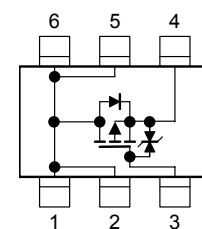
## Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R <sub>th (ch-a)</sub>	56.8	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R <sub>th (ch-a)</sub>	178.5	°C/W

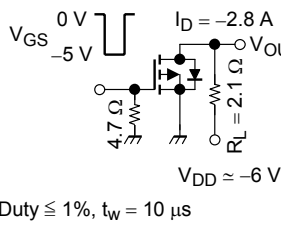
Note 1, (ote 2, Note 3, Note 4 and Note 5: See the next page.

This transistor is an electrostatic-sensitive device. Please handle with caution.

### Circuit Configuration



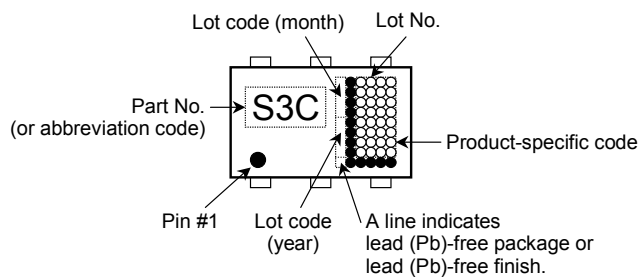
## Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain cut-off current		$I_{DSS}$	$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	-10	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-12	—	—	V
		$V_{(BR)DSX}$	$I_D = -10 \text{ mA}, V_{GS} = 8 \text{ V}$	-4	—	—	
Gate threshold voltage		$V_{th}$	$V_{DS} = -10 \text{ V}, I_D = -200 \mu\text{A}$	-0.5	—	-1.2	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = -1.8 \text{ V}, I_D = -1.4 \text{ A}$	—	65	90	m $\Omega$
		$R_{DS(ON)}$	$V_{GS} = -2.5 \text{ V}, I_D = -2.8 \text{ A}$	—	42	55	
		$R_{DS(ON)}$	$V_{GS} = -4.5 \text{ V}, I_D = -2.8 \text{ A}$	—	29	35	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = -10 \text{ V}, I_D = -2.8 \text{ A}$	6.5	13	—	S
Input capacitance		$C_{iss}$	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	1520	—	pF
Reverse transfer capacitance		$C_{rss}$		—	330	—	
Output capacitance		$C_{oss}$		—	380	—	
Switching time	Rise time	$t_r$	 <p><math>V_{GS}</math> 0 V, -5 V, <math>I_D = -2.8 \text{ A}</math>, <math>V_{OUT}</math>, <math>R_L = 21 \Omega</math>, <math>R_S = 4.7 \Omega</math>, <math>V_{DD} \approx -6 \text{ V}</math> Duty <math>\leq 1\%</math>, <math>t_W = 10 \mu\text{s}</math></p>	—	9.5	—	ns
	Turn-on time	$t_{on}$		—	16	—	
	Fall time	$t_f$		—	28	—	
	Turn-off time	$t_{off}$		—	74	—	
Total gate charge (gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx -10 \text{ V}, V_{GS} = -5 \text{ V}, I_D = -5.5 \text{ A}$	—	20	—	nC
Gate-source charge		$Q_{gs}$		—	15	—	
Gate-drain ("miller") charge		$Q_{gd}$		—	5	—	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

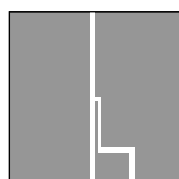
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	$I_{DRP}$	—	—	—	-22	A
Forward voltage (diode)		$V_{DSF}$	$I_{DR} = -5.5 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	1.2	V

## Marking (Note 5)



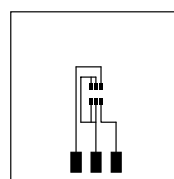
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a) (t = 5 s)  
 (b) Device mounted on a glass-epoxy board (b) (t = 5 s)



(a)

FR-4  
 25.4 × 25.4 × 0.8  
 Unit: (mm)



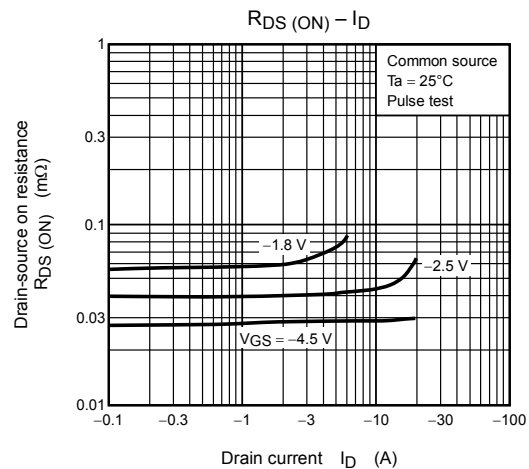
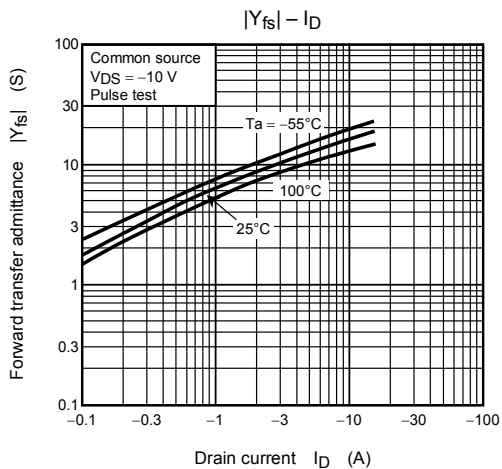
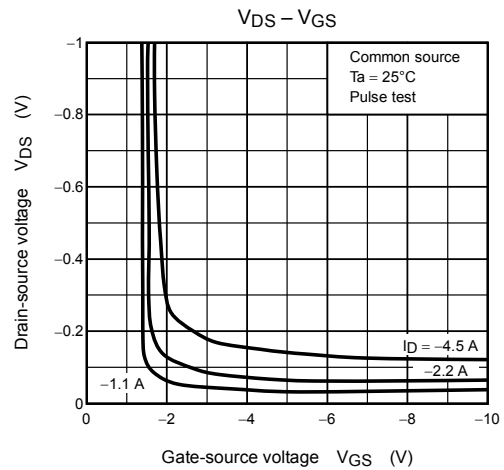
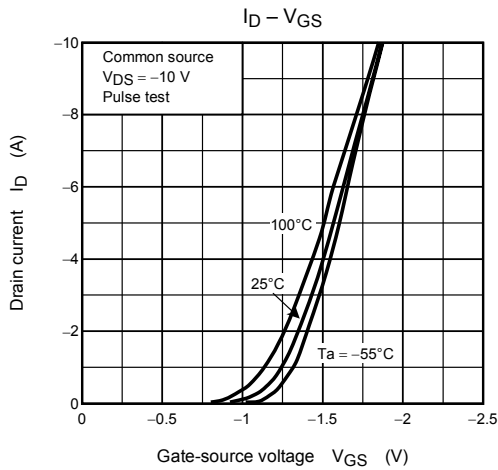
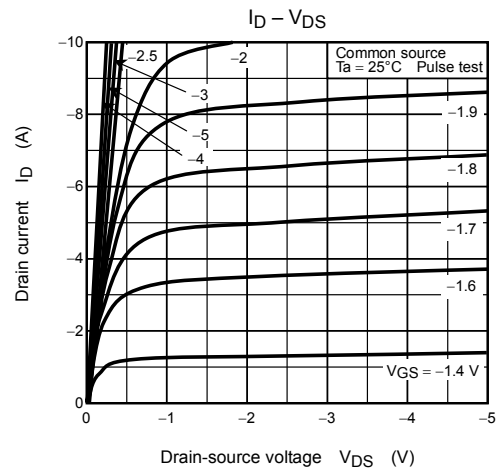
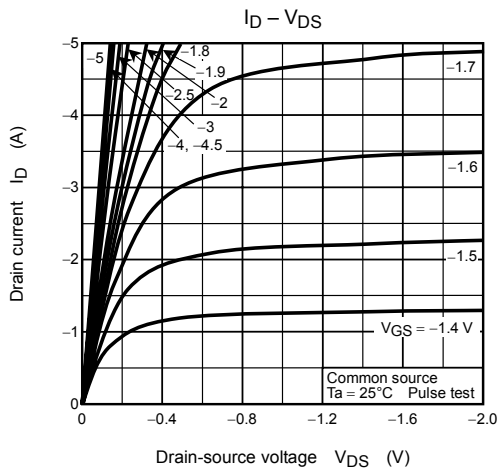
(b)

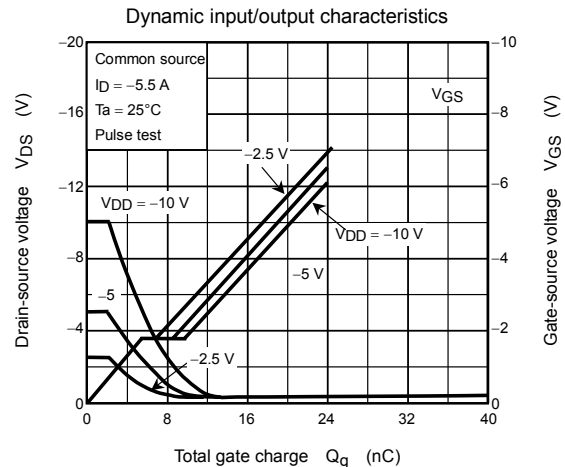
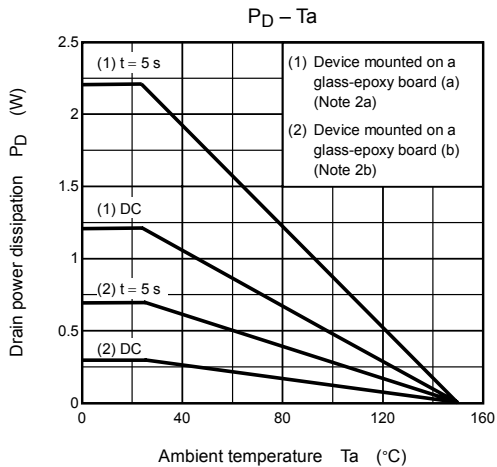
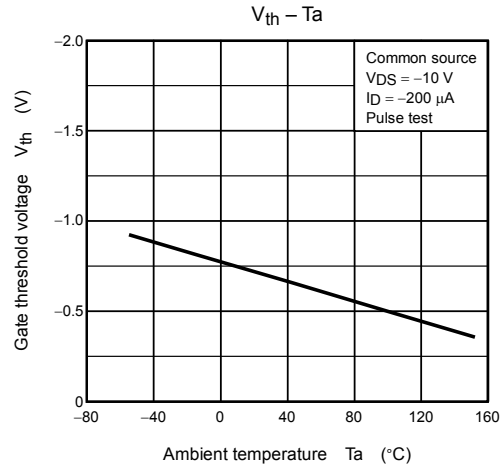
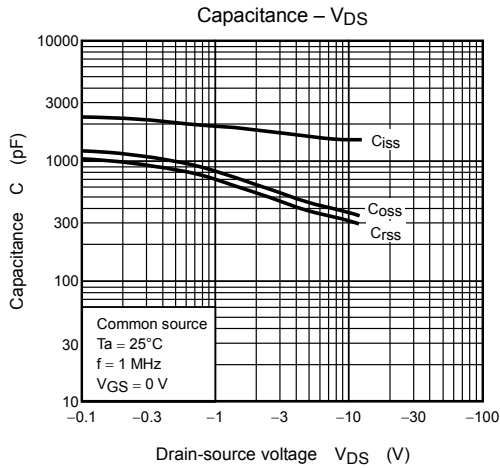
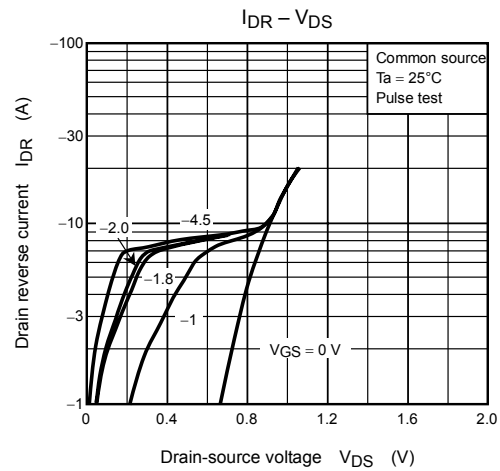
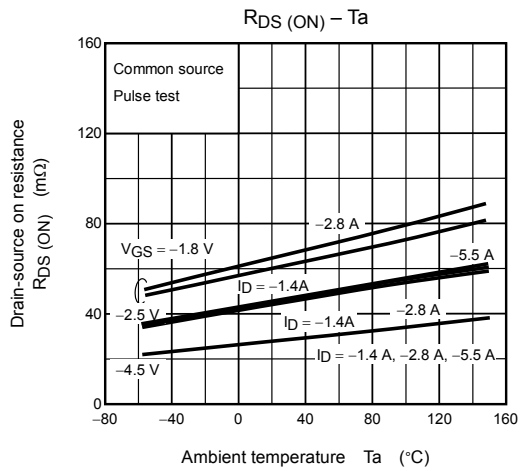
FR-4  
 25.4 × 25.4 × 0.8  
 Unit: (mm)

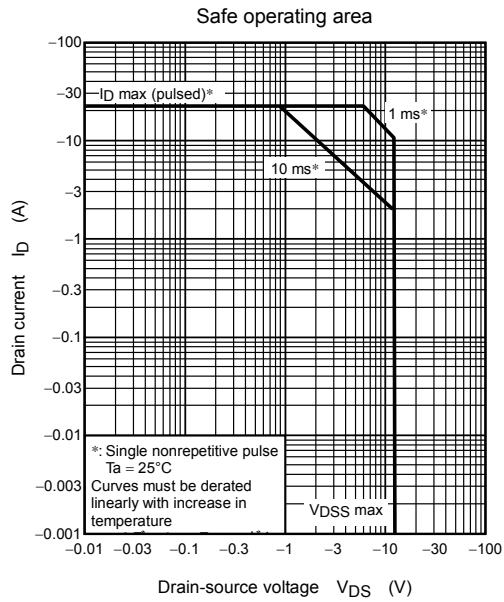
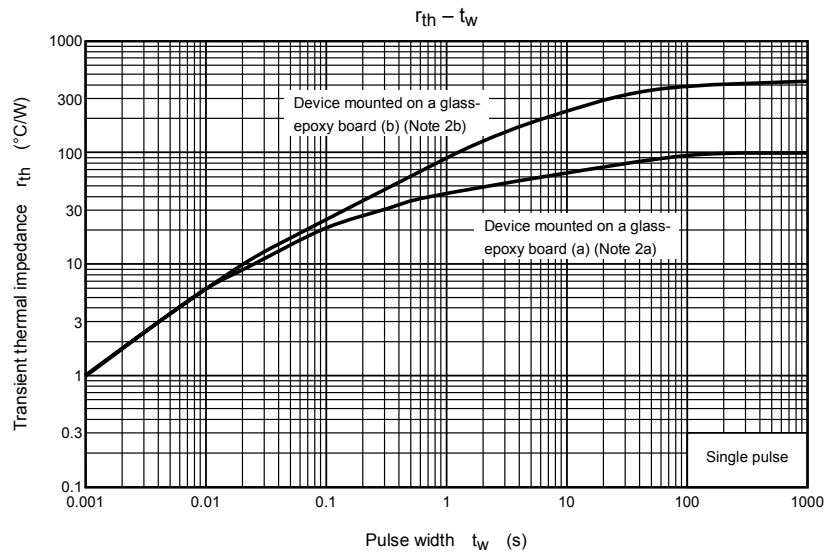
Note 3:  $V_{DD} = -10\text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$  (initial),  $L = 0.5\text{ mH}$ ,  $R_G = 25\ \Omega$ ,  $I_{AR} = -2.75\text{ A}$

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: • on lower left of the marking indicates Pin 1.







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